Assessment Results (All Semesters)

Name:	WONG Tsz Ho	**Date:**	28-Feb-2020
Student No.:	15070475D	**Time:**	05:31 PM

The following results are for student's reference and should not be taken as official certification.

2015/16 Semester 1	**42470-**	**BEng (HONS) ELECTRONIC & INFORMATION ENGINEERING**	**Mode of Attendance: FULL-TIME**

Code	Title	Credit	Grade	Remark Code
AMA1110	BASIC MATHEMATICS I - CALCULUS AND PROBABILITY & STATISTICS	3.00	A	
AP10005	PHYSICS I	3.00	B+	
ELC1011	PRACTICAL ENGLISH FOR UNIVERSITY STUDIES	3.00	B	
ENG1003	FRESHMAN SEMINAR FOR ENGINEERING	3.00	B+	
IC2114	INDUSTRIAL CENTRE TRAINING I FOR EIE	5.00	L	

GPA: 3.50   Sem GPA: 3.50   WGPA: 3.50 (42470-)

2015/16 Semester 2	**42470-**	**BEng (HONS) ELECTRONIC & INFORMATION ENGINEERING**	**Mode of Attendance: FULL-TIME**

Code	Title	Credit	Grade	Remark Code
AMA1120	BASIC MATHEMATICS II - CALCULUS AND LINEAR ALGEBRA	3.00	A	
AP10006	PHYSICS II	3.00	B	
APSS1L01	TOMORROW'S LEADERS	3.00	A	
COMP1B03	INNOVATION AND ENTREPRENEURSHIP: THE RISE OF THE ICT INDUSTRY IN CHINA	3.00	B+	
ELC1013	ENGLISH FOR UNIVERSITY STUDIES	3.00	C+	
ENG2003	INFORMATION TECHNOLOGY	3.00	B	
IC2114	INDUSTRIAL CENTRE TRAINING I FOR EIE	5.00	L	

GPA: 3.40   Sem GPA: 3.33   WGPA: 3.40 (42470-)

2015/16 Semester 3	**42470-**	**BEng (HONS) ELECTRONIC & INFORMATION ENGINEERING**	**Mode of Attendance: FULL-TIME**

Code	Title	Credit	Grade	Remark Code
BME2S03S	REDUCING THE SCIENTIFIC DIVIDE IN SECONDARY STUDENTS THROUGH STEM PROJECTS	3.00	B+	

GPA: 3.41   Sem GPA: 3.50   WGPA: 3.41 (42470-)

2016/17 Semester 1	**42470-**	**BEng (HONS) ELECTRONIC & INFORMATION ENGINEERING**	**Mode of Attendance: FULL-TIME**

Code	Title	Credit	Grade	Remark Code
AMA2111	MATHEMATICS I	3.00	B	
BME1D02	WEARABLE HEALTHCARE AND FITNESS DEVICES FOR EVERYONE	3.00	B+	

Code	Title	Credit	Grade	Remark Code
CBS1102P	ADVANCED COMMUNICATION SKILLS IN CHINESE	3.00	B	
EIE2100	BASIC CIRCUIT ANALYSIS	3.00	A+	
ENG2001	FUNDAMENTALS OF MATERIALS SCIENCE AND ENGINEERING	3.00	C+	
ENG2002	COMPUTER PROGRAMMING	3.00	A	
IC2114	INDUSTRIAL CENTRE TRAINING I FOR EIE	5.00	L	

GPA: 3.41   Sem GPA: 3.42   WGPA: 3.41 (42470-)

2016/17 Semester 2   **42470-**   **BEng (HONS) ELECTRONIC & INFORMATION ENGINEERING**   **Mode of Attendance: FULL-TIME**
11439-YOP   **MINOR IN OPTOELECTRONICS**

Code	Title	Credit	Grade	Remark Code
AF3625	ENGINEERING ECONOMICS	3.00	B	
AMA2112	MATHEMATICS II	3.00	B+	
CBS3241P	PROFESSIONAL COMMUNICATION IN CHINESE	2.00	B+	
EIE2102	BASIC ELECTRONICS	3.00	B	
EIE2211	LOGIC DESIGN	3.00	A	
EIE3312	LINEAR SYSTEMS	3.00	A+	
IC2114	INDUSTRIAL CENTRE TRAINING I FOR EIE	5.00	B+	

GPA: 3.46   Sem GPA: 3.57   WGPA: 3.47 (42470-)

2016/17 Semester 3   **42470-**   **BEng (HONS) ELECTRONIC & INFORMATION ENGINEERING**   **Mode of Attendance: FULL-TIME**
11439-YOP   **MINOR IN OPTOELECTRONICS**

Code	Title	Credit	Grade	Remark Code
GEC1C20P	CHINESE ART AND DESIGN	3.00	B+	
SD1A01M	EVERYDAY ERGONOMICS	3.00	B+	

GPA: 3.46   Sem GPA: 3.50   WGPA: 3.47 (42470-)

2017/18 Semester 1   **42470-**   **BEng (HONS) ELECTRONIC & INFORMATION ENGINEERING**   **Mode of Attendance: FULL-TIME**
11439-YOP   **MINOR IN OPTOELECTRONICS**

Code	Title	Credit	Grade	Remark Code
AMA2104	PROBABILITY AND ENGINEERING STATISTICS	3.00	C+	
AP30009	LASER PRINCIPLES AND APPLICATIONS	3.00	C+	
EIE3100	ANALOGUE CIRCUIT FUNDAMENTALS	3.00	B	
EIE3105	INTEGRATED PROJECT	6.00	L	
EIE3311	COMPUTER SYSTEM FUNDAMENTALS	3.00	B+	
IC382	MULTIDISCIPLINARY MANUFACTURING PROJECT	3.00	L	

GPA: 3.38   Sem GPA: 2.88   WGPA: 3.42 (42470-)

2017/18 Semester 2   **42470-**   **BEng (HONS) ELECTRONIC & INFORMATION ENGINEERING**   **Mode of Attendance: FULL-TIME**
11439-YOP   **MINOR IN OPTOELECTRONICS**

Code	Title	Credit	Grade	Remark Code
EIE3105	INTEGRATED PROJECT	6.00	A	
EIE3331	COMMUNICATION FUNDAMENTALS	3.00	B	
EIE3333	DATA AND COMPUTER COMMUNICATIONS	3.00	B+	
EIE4110	INTRODUCTION TO VLSI AND COMPUTER-AIDED CIRCUIT DESIGN	3.00	D	
EIE4413	DIGITAL SIGNAL PROCESSING	3.00	B	
ELC3521	PROFESSIONAL COMMUNICATION IN ENGLISH	2.00	B	
IC382	MULTIDISCIPLINARY MANUFACTURING PROJECT	3.00	B+	

GPA: 3.33   Sem GPA: 3.13   WGPA: 3.33 (42470-)

2018/19 Semester 1	**42470-** **11439- YOP**	**BEng (HONS) ELECTRONIC & INFORMATION ENGINEERING** **MINOR IN OPTOELECTRONICS**	**Mode of Attendance: FULL-TIME**

Code	Title	Credit	Grade	Remark Code
EIE568	IOT - TOOLS AND APPLICATIONS	3.00	A	

GPA: 3.35   Sem GPA: 4.00   WGPA: 3.36 (42470-)

2018/19 Semester 2	**42470-** **11439- YOP**	**BEng (HONS) ELECTRONIC & INFORMATION ENGINEERING** **MINOR IN OPTOELECTRONICS**	**Mode of Attendance: FULL-TIME**

Code	Title	Credit	Grade	Remark Code
EIE569	SENSOR NETWORKS	3.00	A+	

GPA: 3.38   Sem GPA: 4.00   WGPA: 3.40 (42470-)

2019/20 Semester 1	**42470-** **11439- YOP**	**BEng (HONS) ELECTRONIC & INFORMATION ENGINEERING** **MINOR IN OPTOELECTRONICS**	**Mode of Attendance: FULL-TIME**

Code	Title	Credit	Grade	Remark Code
EIE4100	COMPUTER VISION AND PATTERN RECOGNITION	3.00	B+	
EIE4105	MULTIMODAL HUMAN COMPUTER INTERACTION TECHNOLOGY	3.00	A	
EIE4433	HONOURS PROJECT	6.00	L	
EIE4435	IMAGE AND AUDIO PROCESSING	3.00	B+	
ENG3003	ENGINEERING MANAGEMENT	3.00	B+	

GPA: 3.40   Sem GPA: 3.63   WGPA: 3.42 (42470-)

Overall Result: ELIGIBLE TO PROGRESS

Cumulative Credits Attained: 132.00 (including 8 Training credits)

Other Mandatory Graduation Requirement(s):

Requirement(s)	Fulfillment Status (Latest Year/Sem)
Healthy Life Style	Fulfilled (2017/2)
Work-Integrated Education (42470- -D005)	Fulfilled (2018/2)

Please refer to https://www.polyu.edu.hk/ar/web/en/for-polyu-students/arn-explanation/ for the detailed explanations of the grades and the important notes that are related to your assessment results. Subjects with results not finalised are not listed here.

Eligibility for services and facilities will be invalidated upon your leaving the University. Upon confirmation of your eligibility for graduation, you will no longer be eligible for services and facilities, although some special arrangements may be allowed by some offices for certain services. You can check the Student Handbook for details.